

Docket No. 3008-0028  
File No. 521.41457X00  
Client No. PHCF-01094

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of : **EXPEDITED PROCESSING REQUESTED**

AOYAMA, et al. : Art Unit: 2841

Serial No: 09/892,630 : Examiner: T. Dinh

Filed: June 28, 2001 :

For: LEAD-FREE SOLDER, AND CONNECTION LEAD AND ELECTRICAL  
COMPONENT USING SAID LEAD-FREE SOLDER

**AFTER FINAL AMENDMENT UNDER 37 CFR §1.116**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

May 9, 2006

*please return*  
*TJ*  
*5-10-06*  
Sir:

This Amendment is filed in response to the final Official Action dated March  
14, 2006, the time for response to which is up to and including June 14, 2006.

Please amend the above-identified application as listed below and as set forth on the  
following pages.

**Amendments to the Claims**

**Remarks** are included following the amendments